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# **Amplifier Transistor** NPN Silicon

## **MPS4124**

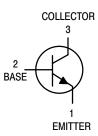
## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CE</sub>	25	Vdc
Collector-Base Voltage	V <sub>CB</sub>	30	Vdc
Emitter-Base Voltage	V <sub>EB</sub>	5.0	Vdc
Collector Current — Continuous	I <sub>C</sub>	200	mAdc
Total Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	625 5.0	mW mW/°C
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C



## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W



## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage $(I_C = 1.0 \text{ mA}, I_B = 0)$	V <sub>(BR)</sub> CEO	25	_	Vdc
Collector–Base Breakdown Voltage ( $I_C = 10 \mu A, I_E = 0$ )	V <sub>(BR)</sub> CBO	30	_	Vdc
Emitter–Base Breakdown Voltage ( $I_C = 0$ , $I_E = 10 \mu A$ )	V <sub>(BR)EBO</sub>	5.0	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 20 V, I <sub>E</sub> = 0)	Ісво	_	50	nAdc
Emitter Cutoff Current $(V_{EB} = 3.0 \text{ V, } I_{C} = 0)$	I <sub>EBO</sub>	_	50	nAdc

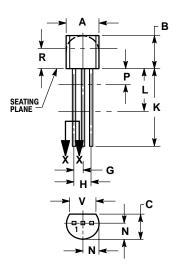
## **MPS4124**

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS				•
DC Current Gain $ (I_C = 2.0 \text{ mA}, V_{CE} = 1.0 \text{ V}) $ $ (I_C = 50 \text{ mA}, V_{CE} = 1.0 \text{ V}) $	h <sub>FE</sub>	120 60	360 —	_
Collector–Emitter Saturation Voltage ( $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$ )	V <sub>CE(sat)</sub>	_	0.3	Vdc
Base–Emitter Saturation Voltage ( $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$ )	V <sub>BE(sat)</sub>	_	0.95	Vdc
SMALL-SIGNAL CHARACTERISTICS	·		•	•
Current–Gain — Bandwidth Product ( $I_C = 10 \text{ mA}, V_{CE} = 20 \text{ V}, f = 100 \text{ MHz}$ )	f <sub>T</sub>	170	_	MHz
Output Capacitance $(V_{CB} = 5.0 \text{ V}, I_E = 0, f = 1.0 \text{ MHz})$	C <sub>ob</sub>	_	4.0	pF
Input Capacitance ( $V_{EB} = 0.5 \text{ V}, I_{C} = 0, f = 1.0 \text{ MHz}$ )	C <sub>ib</sub>	_	13.5	pF
Small–Signal Current Gain ( $I_C = 2.0 \text{ mA}, V_{CE} = 1.0 \text{ V}, f = 1.0 \text{ kHz}$ )	h <sub>fe</sub>	120	480	_
Noise Figure (I <sub>C</sub> = 100 $\mu$ A, V <sub>CE</sub> = 5.0 V, R <sub>S</sub> = 1.0 k $\Omega$ , f = 1.0 kHz)	NF	_	5.0	dB

## **PACKAGE DIMENSIONS**

TO-92 (TO-226) CASE 29-11 ISSUE AL





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
_	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

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